

GE2/1 & ME0 backend electronics

Evaldas Juska (TAMU)

- **Common backend**

- Aiming to have common ATCA-based hardware for GE2/1, ME0, CSC
- Have identified the APT board as a baseline choice that meet the requirements of all three systems
- ATCA test stand at CERN is already underway (all components ordered)
 - Additional test stands are being planned

- **Firmware reusability between all GEM systems**

- GE1/1 backend firmware was designed from ground up to be flexible
 - Reusable across different hardware architectures
 - Reusable across the different GEM systems: GE1/1, GE2/1, ME0
 - Software interface is also kept compatible
- This has contributed a lot in the fact that we were able to get GE2/1 and ME0 tests working so quickly
- Even CSC FED system has reused a lot of the GEM firmware backend components

- **Hardware support**

- CTP7 is the main hardware platform right now
- GLIB support is being finalized (more details in Laurent's talk)
- Will start on adding APT support soon as the ATCA stand is setup
- Another low cost alternative is being investigated for test stands

2. GE2/1 System Overview

- **Overview**

- Functionality is the same as GE1/1
- Hardware is ATCA

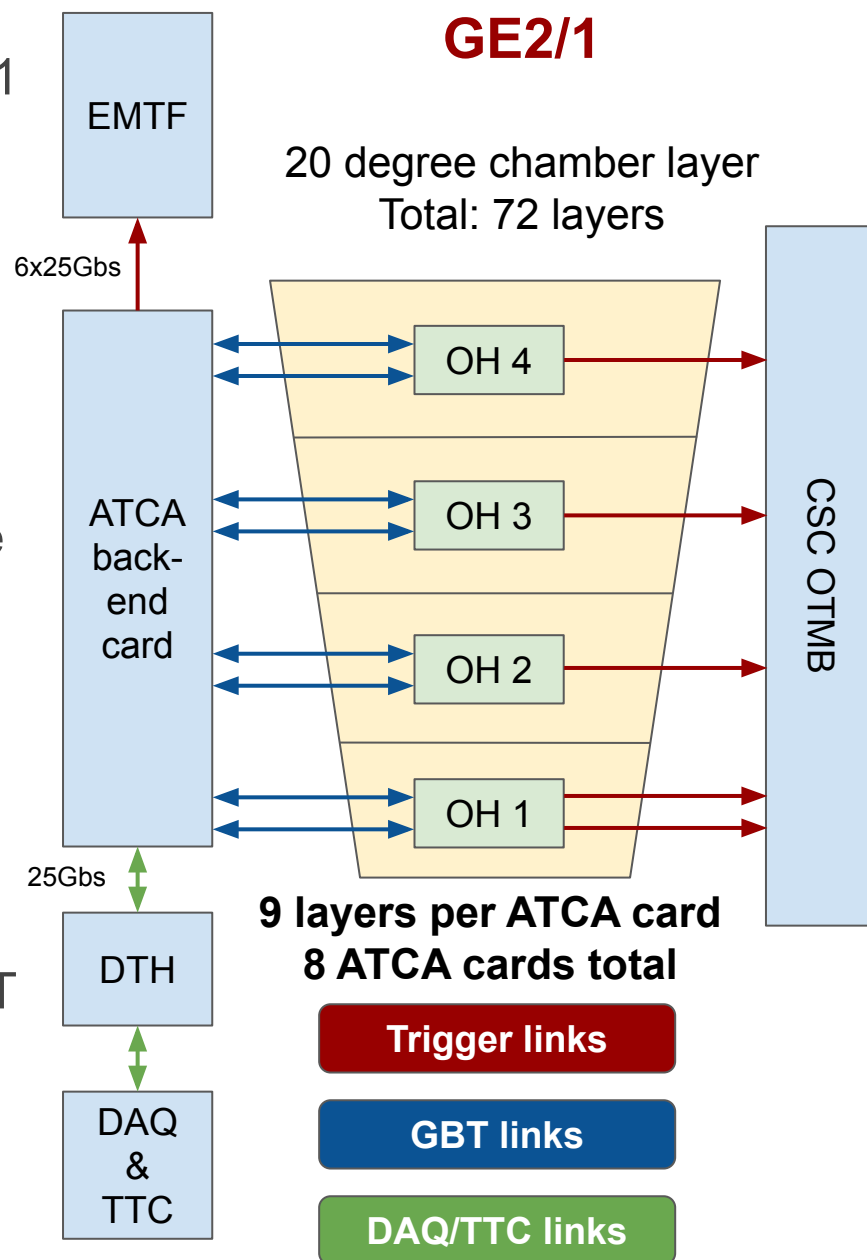
- **Firmware**

- Already have a fully functional firmware working on CTP7, which is being used by the integration team at CERN regularly
- Final system-level firmware will be adapted to new ATCA hardware
 - Fiber links, clocking, etc..
- All the GEM logic can be directly reused adjustments

- **Links**

- 576 bidirectional GBTX links
- Trigger data also received via GBT
- 48x 25Gb/s links to EMTF
- 8 ATCA cards total

- **Estimated data rate: 4.6 Gb/s**



3. GE2/1 differences w.r.t. GE1/1

- **2 GBTX & 12 VFATs per OH instead of 3 GBTX & 24 VFATs**
 - Elink maps are different
 - Minor change
- **PROMless programming, and SCA interfacing**
 - Different OH FPGA
 - Elink maps are different
 - SCA I/O is different
 - All are minor changes
- **Trigger data embedded into GBT links**
 - Notice that there were no red lines from OH to backend in previous slide
 - More on this in the next slide
- **ATCA interfaces**
 - New generation of FPGA (Virtex Ultrascale+)
 - The backend FPGA I/O will be different
 - Interfacing with DTH instead of AMC13
- **Interface documentation can be found [here](#)**

4. GE2/1 trigger data to backend

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● **GBT bandwidth in GE2/1**

- 2.24Gb/s of unused bandwidth from OH to backend in current prototype
- Next prototype will use GBTX wide-bus mode to extend this to 3.52Gb/s
- This is more than enough to fit the sbits cluster (trigger) data
 - Need to be able to transfer up to 5 clusters per BX = 2.6Gb/s
 - Extra bandwidth will be used for error detection codes (CRC) and provide extra margin for possible future needs
- Transmitting trigger data on GBT links is very similar to ME0
- Can remove the extra links to backend, and also one VTTX on OH
- Allows to fit the backend into 8 cards

● **GBTX wide-bus mode**

- Standard feature of GBTX where asymmetric bandwidth is needed
- Converts 4 output elinks to input elinks (each running at 320Mb/s)
- In our case the 4 output elinks were unused
- In the direction of OH to backend the Forward Error Correction code is removed and replaced by user data
 - Note that DAQ data already includes CRC for error detection
 - We will also add CRC to the trigger data
- CSCs are operating with CRCs (no FEC) for many years
 - They also have a new board using GBTX in wide-bus mode

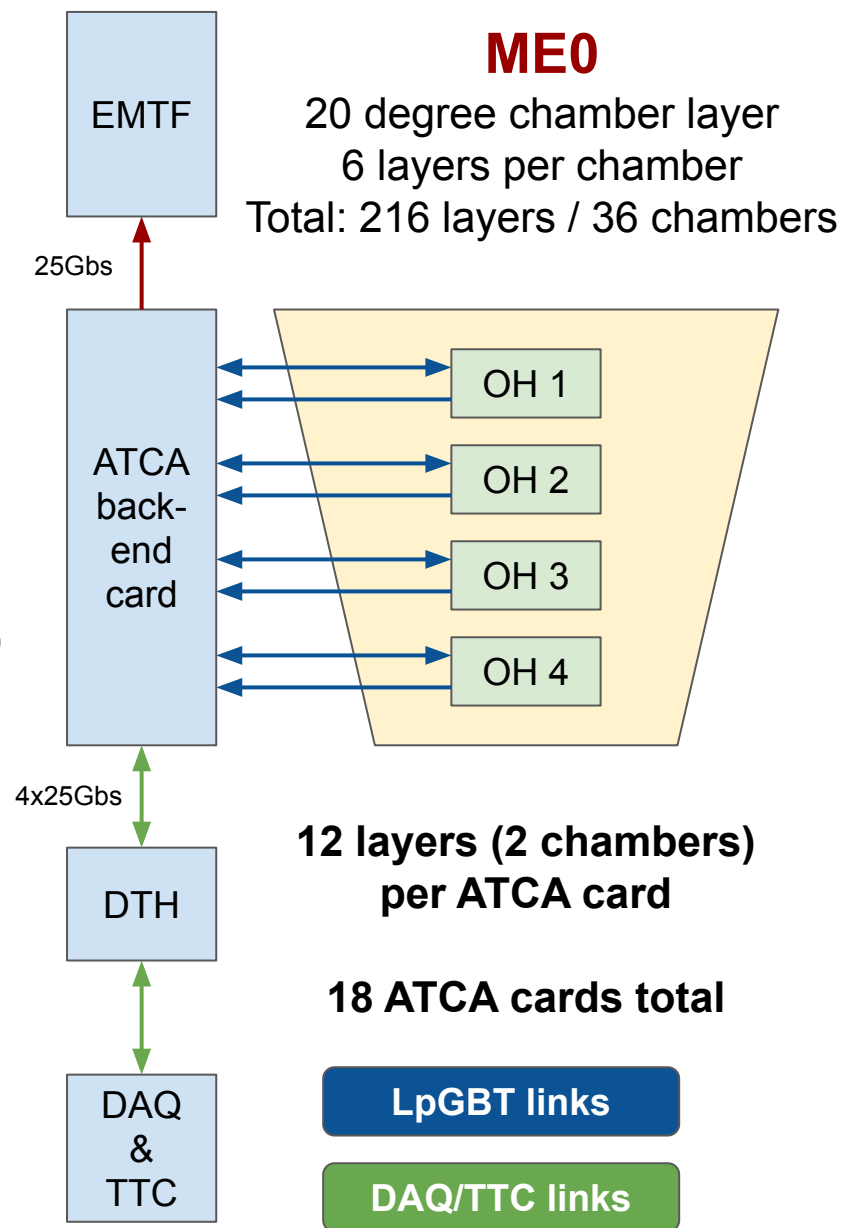
5. ME0 System Overview

- **No FPGA on OH**

- All components are rad-hard
- Lossless DAQ and trigger data transmission to the backend

- **Backend requirements**

- 2 stacks per card
 - 18 cards total
- 6 layer stub building
 - Up to 16 stubs per BX
 - Very resource intensive
- High number of LpGBT cores (96)
- High DAQ bandwidth
 - 706Gb/s for full system
- Number of links
 - 864 bidirectional (LpGBT)
 - 864 unidirectional (LpGBT)



6. ME0 backend firmware status

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- **Functional firmware for CTP7 already implemented, being tested**
 - 10.24Gb/s transceivers implemented and verified
 - LpGBT cores have been integrated and tested
 - Internal Control of the master LpGBT is working, slave is being tested
 - Communication to VFATs is already working!
 - Both fast control and slow control
 - Need addressing functionality to test full capabilities of slow control
 - Basic trigger data processing is in the works
 - See Andrew's report for more details on the testing progress
- **Differences w.r.t. GE1/1 are much greater**
 - LpGBT is quite different compared to GBTX both on frontend and backend sides
 - No OH FPGA to worry about (no PROMless, no FPGA slow control)
 - Only 6 VFATs per OH
 - So far DAQ events have been structured around OH
 - 1 block per OH containing all VFAT data
 - For ME0 will change this to be 1 block per layer or even stack
 - Biggest change by far: 6 layer stub building for trigger
 - Work on this should start soon
 - Simulation studies are also needed

7. ME0 Stub Building

● Local 6 layer stub finding logic resources

- FPGA resource intensive task
- CSC has a dedicated board (OTMB) for this function (for each chamber)
 - Current firmware for ME1/1 OTMB uses about 80k virtex 6 “logic cells”
- ME0 has 1536 di-strips vs. 224 half-strips in ME1/1
 - Simply extrapolating linearly results in 549k “logic cells” per ME0 chamber
- We will have 2 ME0 chambers per ATCA card, and build up to 16 stubs
 - Extrapolated CSC algorithm would take about half of VU9P resources
- Although ME0 stub-finding firmware most likely will be very different from CSCs, and possibly use less resources than this simple extrapolation

● Saves a lot of bandwidth in trigger and DAQ

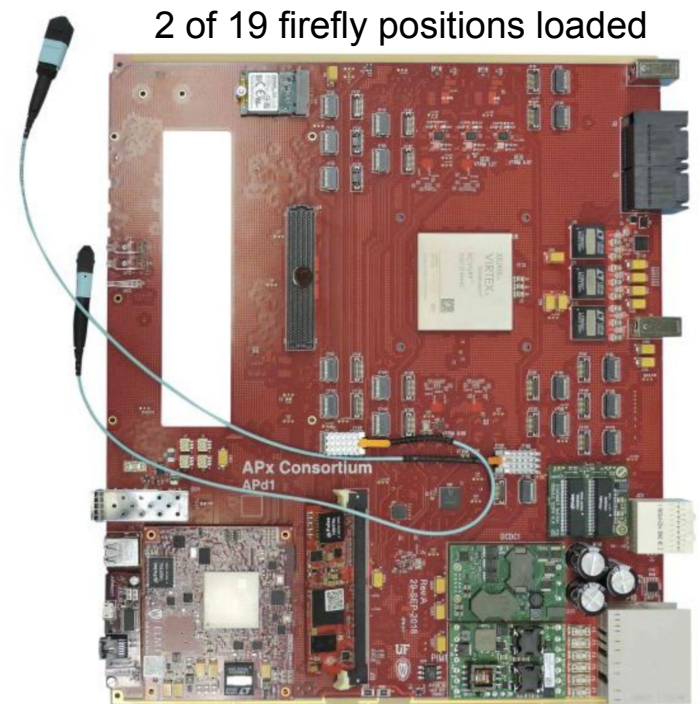
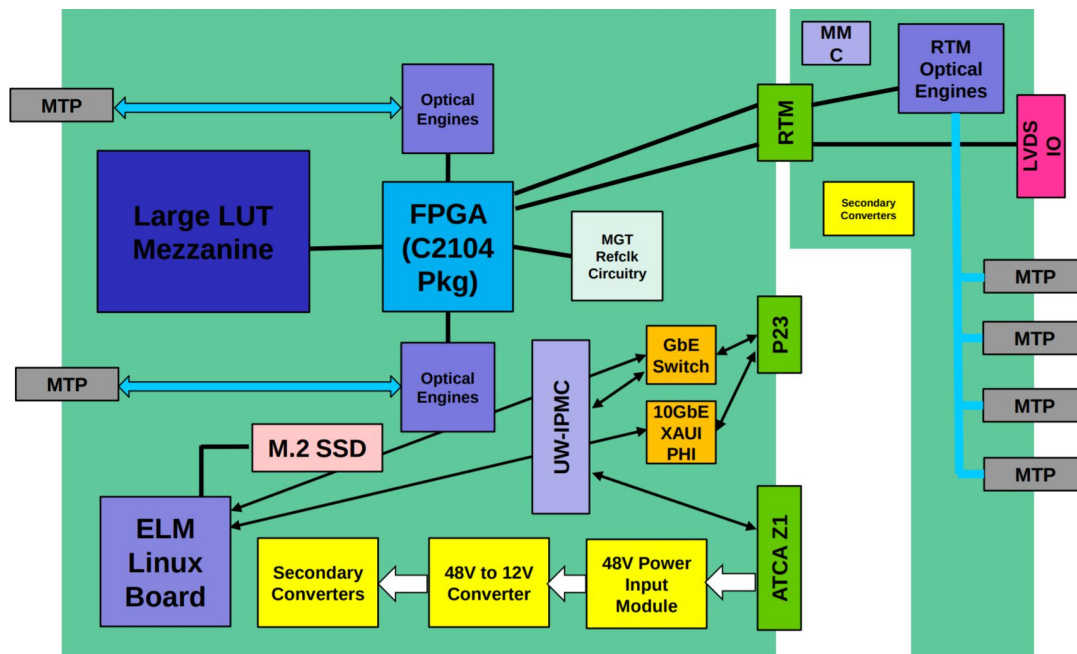
- Only one 25Gb/s link to EMTF per 2 chambers is needed to transmit 16 stubs per BX per chamber
- DAQ data can be selectively readout based on stub presence (optional)

		Stub #1			Stub #2			Stub #3	
X	X	X	X	X	X	X	X	X	
			X			X		X	
X	X	X	X	X	X	X	X	X	
	X	X	X		X	X	X	X	
	X		X					X	
		X	X		X	X			

8. ATCA APT card

- **Advanced Processor by APx consortium (baseline option)**

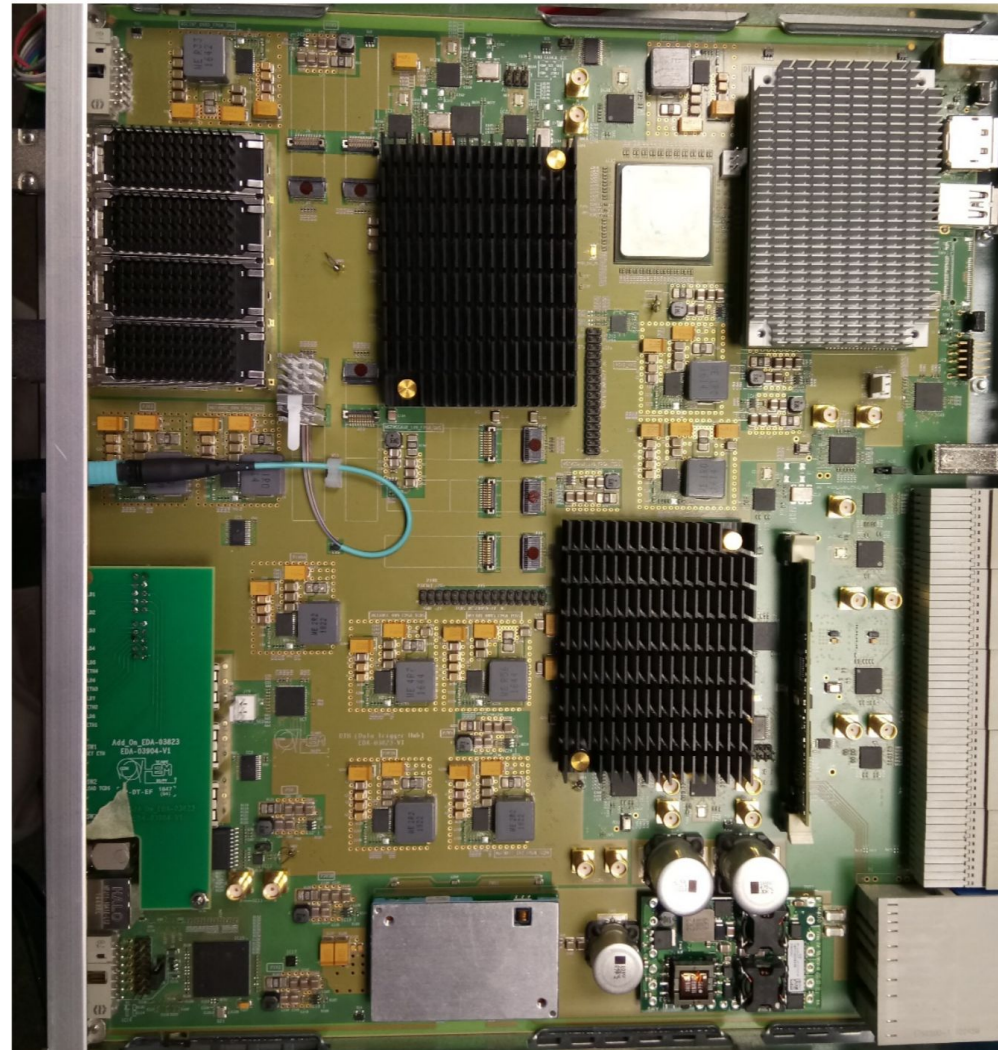
- Large VU9P FPGA
- Up to 100 x 28Gb/s optical TX and RX
- Onboard linux, similar to CTP7 (but faster CPU and faster link to FPGA)
- Satisfies all GE2/1, ME0, and CSC needs
- We will have a prototype at CERN by the end of 2019



9. DTH

● Status

- First prototype produced
- Used by DAQ and TCDS groups to develop firmware
- Second prototype will be available to subsystems in January 2020
- Current version supports 400Gb/s bandwidth
- Final card expected to support 800Gb/s
- We need one card per crate
 - 1 for GE2/1
 - 2 for ME0
 - Must support at least 800Gb/s per card



10. CTP7 boards

- **Currently using 15 CTP7s for GE1/1, GE2/1, ME0, CSC**
 - 6 boards at QC7/8 (one endcap worth of boards)
 - 2 at 904 integration stands (one for GE1/1, and one for GE2/1 / ME0)
 - 1 at P5
 - 5 boards at university test stands (TAMU, UCLA, Rice, ULB)
 - 1 board used by CSC
 - We will acquire 2 more boards in Q2 next year
- **Minus endcap commissioning at P5 (4 CTP7s as of October 2019)**
 - Covers $\frac{2}{3}$ of the endcap, will have to rotate until June 2020
 - 1 board is already at P5
 - 1 board comes from TAMU
 - 2 or possibly 3 boards come from QC7
 - These are the two additional QC7 stations
 - We are planning to replace them with GLIBs
- **Both endcaps commissioning at P5 (12 CTP7s as of June 2020)**
 - All boards from QC7/8 will move to P5
 - 2 new boards will be acquired
 - 2 boards will come from test stands (one ops spare will be at 904 stand)
 - Note: ATCA test stands will be already available

11. CTP7 and ATCA alternatives

- **High density**

- Due to high density of CTP7, the number of boards is tight
- Test stands usually only require to connect to one chamber
 - 8% of the board's capability
- Density and cost of ATCA cards is even higher

- **Alternatives**

- Low cost alternative cards are useful for test stand use
- Currently GLIB serves that purpose
 - Firmware is being updated by Laurent
- GLIB has several limitations:
 - Optical links limited to 6Gb/s by FPGA
 - Only 4 optical links in standard configuration
 - Can be extended to 8 links with a mezzanine card
 - Ok for GE1/1 and GE2/1, but larger test sites require a lot of cards (FIT)

12. CTP7 and ATCA alternatives

- **FPGA based PCIe “accelerator” cards for PC**

- Available from multiple vendors (e.g. Bittware, Xilinx)
 - Other projects at CERN are also using these cards (Bittware also mentioned CMS)
- Typically offer 16 optical links @ up to 25Gb/s
 - Some can be extended to 32 links, but 16 is enough for most test sites
 - Compatible with GE1/1, GE2/1, ME0, CSC needs
- FPGA choice is wide, but cards with 16 links normally have VU9P or VU13P
- We don't yet have quotes, but expecting the cost to be around \$6k
- Copper I/O is available on some cards
 - E.g. for external trigger signals, or synchronization across several cards
- Optional DDR4 modules can be installed
 - E.g. useful for simulated FE data for ME0 algorithm development
- PCIe interface provides a fast & high bandwidth communication w/ CPU
 - Fast execution of calibration scans
 - DAQ can write directly to the host PC's system memory
- Possible use cases
 - Test stand at FIT
 - QC7 for GE2/1
 - Other test stands



13. Summary

- **Firmware status is in good shape**

- Fully functional CTP7-based firmware for GE2/1, used regularly
- CTP7-based firmware for ME0 being tested now with good results
- Proven flexibility and portability across different systems

- **ATCA status**

- Test stand at CERN expected before the end of the year
- Do not expect any showstoppers
- Some time will have to be invested to make the current firmware compatible

- **Cards for test stands**

- As GE1/1 is moving towards commissioning, the CTP7s are becoming more scarce
- Being compensated by the GLIB developments
- Another low cost alternative is being pursued
 - Fast optical links (same as ATCA)
 - Higher link count than GLIB
 - Large FPGA